

### ***GL Silicon N-Channel Power MOSFET***

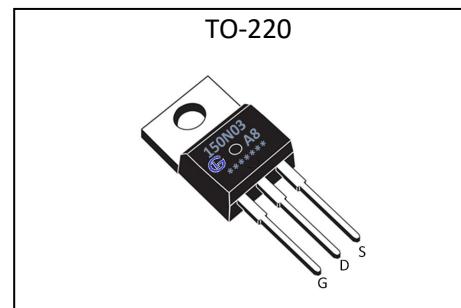
#### **General Description**

The GL150N03A8 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. The package form is TO-220, which accords with the RoHS standard.

$V_{DSS}$	30	V
$I_D$	150	A
$P_D$	130	W
$R_{DS(ON)type}$	2.25	$m\Omega$

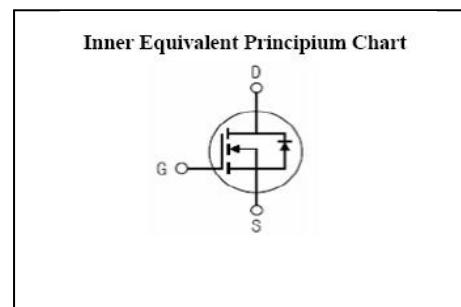
#### **Features**

- $R_{DS(ON)} < 3.0m\Omega$  @  $V_{GS}=10V$  (Typ2.25mΩ)
- High density cell design for ultra low  $R_{ds(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation



#### **Applications**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



#### **Absolute** ( $T_c=25^\circ C$ unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	30	V
$I_D$	Continuous Drain Current( $T_c=25^\circ C$ )	150	A
	Continuous Drain Current( $T_c=100^\circ C$ )	110	A
$I_{DM}$	Pulsed Drain Current	600	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$P_D$	Power Dissipation	130	W
$E_{AS}$	Single pulse avalanche energy <sup>a5</sup>	1800	$mJ$
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	175, -55 to 175	$^\circ C$

Caution Stresses greater than those in the "Absolute Maximum Ratings" may cause permanent damage to the device



# GL150N03A8

## GL Silicon N-Channel Power MOSFET

**Electrical Characteristics** ( $T_c=25^\circ C$  unless otherwise specified)

### OFF Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	--	--	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=30V, V_{GS}=0V, T_a = 25^\circ C$	--	--	1.0	$\mu A$
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20V$	--	--	0.1	$\mu A$
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20V$	--	--	-0.1	$\mu A$

### ON Characteristics<sup>a3</sup>

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10V, I_D=25A$	--	2.25	3.0	$m\Omega$
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.6	3.0	V
Pulse width $t_p \leq 380\mu s, \delta \leq 2\%$						

### Dynamic Characteristics<sup>a4</sup>

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$g_{fs}$	Forward Transconductance	$V_{DS}=5V, I_D=25A$	30	--	--	S
$C_{iss}$	Input Capacitance		--	5000	--	
$C_{oss}$	Output Capacitance	$V_{GS}=0V, V_{DS}=15V, f=1.0MHz$	--	1150	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	580	--	

### Resistive Switching Characteristics<sup>a4</sup>

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=15V, I_D=25A$	--	26	--	ns
$t_r$	Rise Time		--	24	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	95	--	
$t_f$	Fall Time		--	40	--	
$Q_g$	Total Gate Charge	$V_{DD}=15V, I_D=25A$	--	35	--	nC
$Q_{gs}$	Gate to Source Charge		--	8	--	
$Q_{gd}$	Gate to Drain ("Miller" )Charge		--	13	--	

***GL Silicon N-Channel Power MOSFET***
**Source-Drain Diode Characteristics**

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I <sub>S</sub>	Continuous Source Current <sup>a2</sup> (Body Diode)		--	--	150	A
V <sub>SD</sub>	Diode Forward Voltage <sup>a3</sup>	I <sub>S</sub> =150A, V <sub>GS</sub> =0V	--	--	1.2	V

**Thermal Characteristics**

Symbol	Parameter	Typ.	Units
R <sub>θJC</sub>	Junction-to-Case <sup>a2</sup>	1.15	°C/W

<sup>a1</sup>: Repetitive Rating: Pulse width limited by maximum junction temperature.

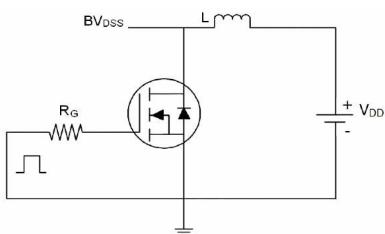
<sup>a2</sup>: Surface Mounted on FR4 Board, t≤10sec.

<sup>a3</sup>: Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%.

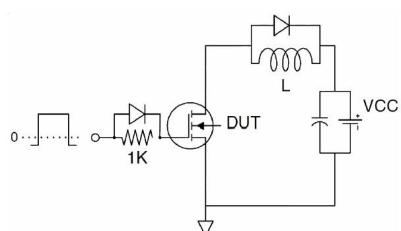
<sup>a4</sup>: Guaranteed by design, not subject to production

<sup>a5</sup>: E<sub>AS</sub> condition: T<sub>j</sub>=25°C, V<sub>DD</sub>=15V, V<sub>GS</sub>=10V, L=1.0mH, R<sub>G</sub>=25Ω

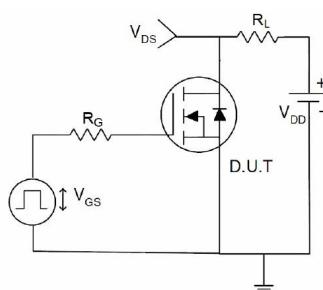
**Test Circuits**

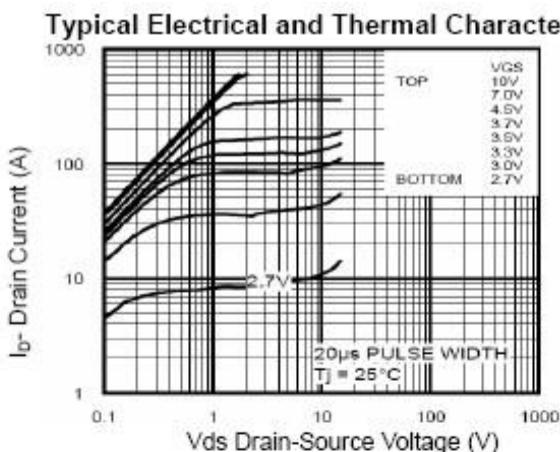
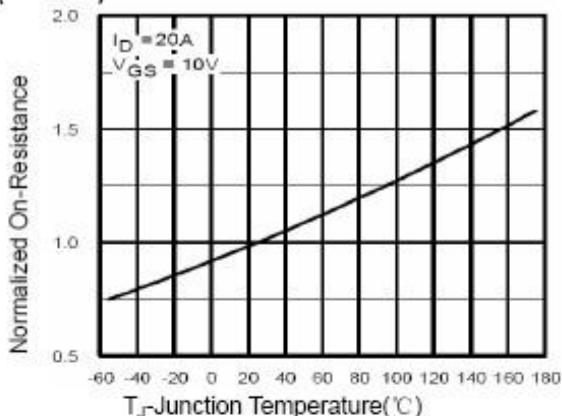
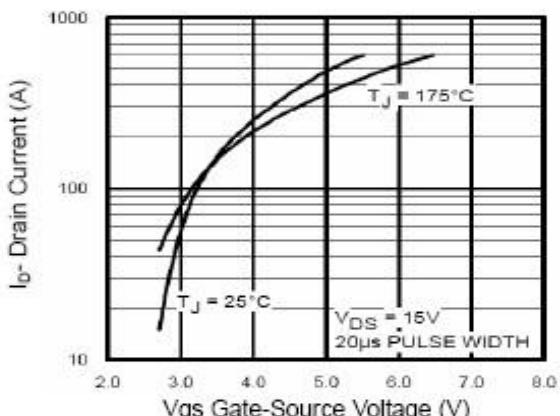
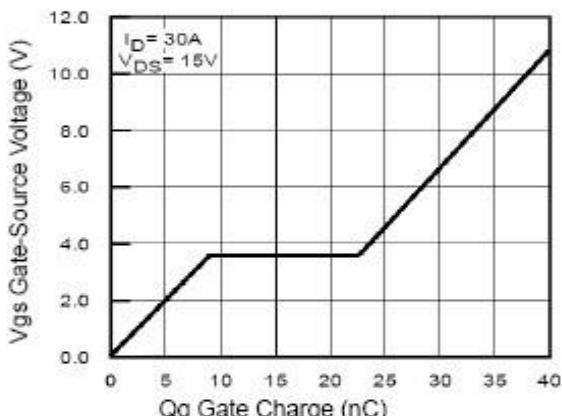
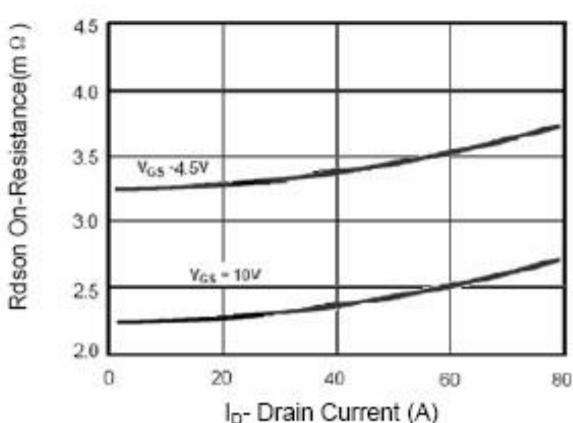
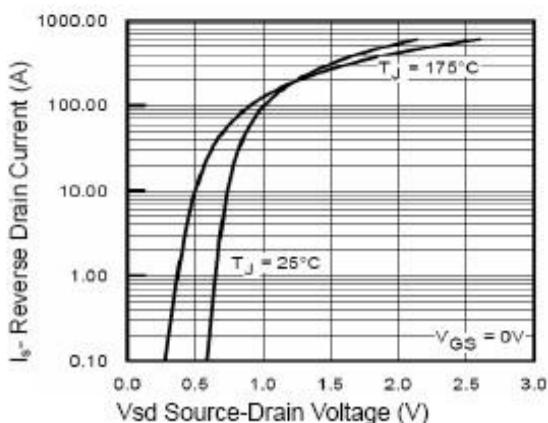
1) E<sub>AS</sub> test Circuits


## 2) Gate charge test Circuit:



## 3) Switch Time Test Circuit:



***GL Silicon N-Channel Power MOSFET***
**Characteristics Curves**

**Figure 1 Output Characteristics**

**Figure 4 Rdson-JunctionTemperature**

**Figure 2 Transfer Characteristics**

**Figure 5 Gate Charge**

**Figure 3 Rdson- Drain Current**

**Figure 6 Source- Drain Diode Forward**

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